DSG Ansys R&D Meeting Minutes

Date: November 30, 2023 Time: 2:00 PM – 2:30 PM

<u>Attendees</u>: Aaron Brown, Peter Bonneau, Pablo Campero, Brian Eng, George Jacobs, Tyler Lemon, and Marc McMullen

1. NPS thermal analysis with Ansys Mechanical

Aaron Brown

1. Ansys Mechanical crashed and simulation stopped; will proceed using internal heat generation option

2. NPS thermal analysis with Ansys Mechanical and Fluent in transient mode

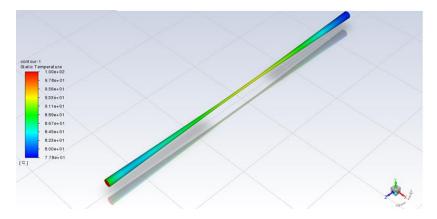
Pablo Campero

- 1. Common model to be used in both simulations is in progress
 - Added 1080 slice volume (20x20x1 mm) to set the internal heat generation
 - Reduced each of the 1080 crystals at the mu-metal section by 1 mm (z-axis direction)
- 2. Discussed Share Topology option, which is not recommended for Ansys Mechanical (per Ansys Tech support), but is needed for Ansys Fluent simulations

3. EIC beampipe Ansys Fluent thermal analysis

Pablo Campero

- 1. Completed mesh using Ansys Fluent with Mesh; final has ~29 million cells
- 2. Set up Ansys Fluent with thermal boundary condition
 - Assigned material thermal properties for aluminum, thermal heat insulator (aerogel, polyimide, aluminum), and beryllium
 - Added thickness for the insulator using Conduction Shell options in Fluent
 - Set convection for exterior walls of aluminum and beryllium
- 3. Ran thermal simulation
 - Set 300 iterations in steady state analysis mode; converged at 142 iterations
 - Generated temperature contour plot
 - Measurement of temperatures for critical points of the model is in progress



Isometric view of contour temperature for 9-m EIC beampipe